DATA SHEET

Part No.	AN15524A			
Package Code No.	T0220-7A			

SEMICONDUCTOR COMPANY MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

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AN15524A Silicon Monolithic Bipolar IC

Overview

AN15524A are ICs for CRT vertical deflection output. AN15524A can directly drive a deflection coil with saw wave output from a signal processing IC.

With its maximum output current of 1.6 A[p-p], AN15524A are suitable for the use of driving of 14 inch to 21 inch monitors.

Features

- Vertical output circuit
- Built-in pump up circuit
- Built-in thermal protection circuit
- Absolute maximum rating 70 V
- Maximum output current 1.6 A[p-p]

Applications

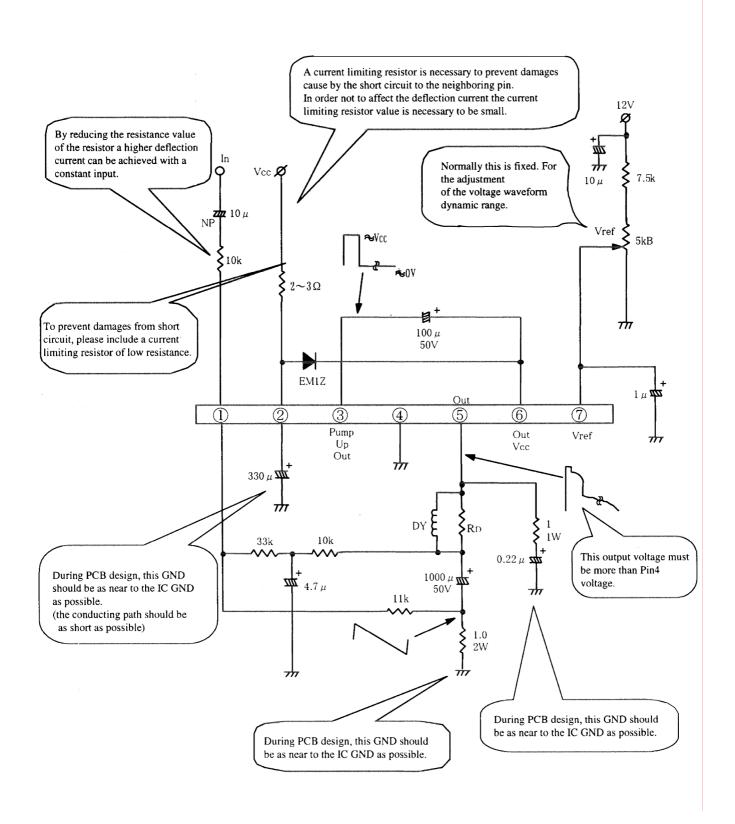
- CRT vertical output
- TV sets and displays

Package

• T0220-7pin Plastic Package with Fin

Application Circuit Example

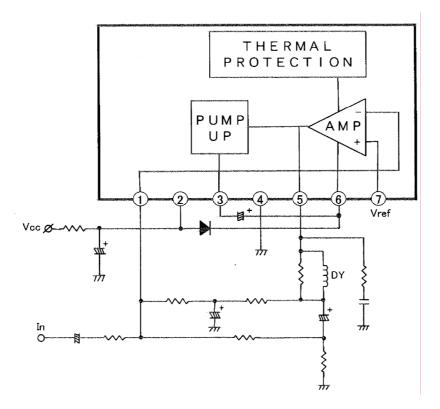
AC Coupling



- Application Circuit Example (continued)
 DC Coupling
 - Vcc=12V Ø Vcc=-12V ø $330 \,\mu$ 330 µ <u>π</u> 16V 700 16V 2~3 $2\sim3$ th π 7.5k ŧ 8 **\$** 5kB 100 μ 50V 1μ 🗫 π 777 Out (1)2 4 3 5 6 \bigcirc Pump Out Vref Up Out Vcc 11 Rl **1**0p In (10k) ł 0 2W <u>Т</u> **Ξ** 0.22 μ 300 2W m \sim R2 (12k) ş 1.0 2W 1000p This output voltage must be more than Pin4 $\frac{1}{m}$ voltage. $\frac{1}{2}$

In order to get required gain, it is necessary to adjust the R1 and R2.

Block Diagram



■Pin Descriptions

Pin No.	Pin name
1	Inverting input
2	Power supply
3	Pump-up output
4	GND
5	Vertical output
6	Vertical output power supply
7	Non-inverting input

Absolute Maximum Ratings

А	Absolute Maximum Ratings							
No.	Parameter Symbol Rating				Unit	Note		
1	Storage temperature	T _{stg}	– 55 te	o +150	°C	* 1		
2	Operating ambient temperature	T _{opr}	- 20 1	to +70	°C	* 1		
3	Operating ambient atmospheric pressure	P _{opr}	1.013×10^{5}	\pm 0.61 $ imes$ 10 ⁵	Pa			
4	Operating constant gravity G _{opr} 9810				m/S ²			
5	Operating shock	ock S _{opr} 4 900		m/S ²				
6	Supply voltage	V _{CC2}	3	v				
7	Supply current	I _{CC2}	30	mA				
8	Power dissipation	P _D	1.5		W	* 2		
9	Circuit voltage	V ₅₋₄ , V ₆₋₄ 0 70		v				
10	Circuit voltage	V_{7-4} , V_{1-4}	0 V ₂₋₄		v			
11	Circuit current	I_5 , I_3	- 1.5 1.5		A[o-p]			

Note) *1: Expect for the operating ambient temperature and storage temperature , all ratings are for Ta = 25° C.

Note) *2: The power dissipation shall be at $Ta = 70^{\circ}C$ in free air, without heat sink. (refer to sheet no. 13)

Operating Supply Voltage Range

Parameter	Symbol	Range	Unit	Note
Operating supply voltage range	V _{CC2}	12 to 30	V	
Deflection output current	I _{5p-p}	to 1.6	A [p-p]	

В	Parameter	Symbol	Test circuits Conditions		Limits			Unit	Note
No.	Parameter	Symbol		Min	Тур	Max	Unit	Note	
1	Mid-point current	V _{MID}	2	$V_{\rm CC} = 24 \text{ V}$	11.5	12	12.5	V	
2	Output saturation voltage (Lower)	V ₅₋₄	3	$V_{CC} = 24 V$ I5 = 0.8 A	—	1.5	2.5	V	
3	Output saturation voltage (Upper)	V ₆₋₅	4	$V_{CC} = 24 V$ I5 = -0.8 A	—	2.4	3.4	V	
4	Pump-up charge saturation voltage	V ₃₋₄	5	$V_{CC} = 24 V$ $I3 = 20 mA$		0.8	1.2	V	
5	Pump-up discharge saturation voltage	V ₂₋₃	6	$V_{CC} = 24 V$ I3 = -0.8 A		1.8	2.8	V	

\blacksquare Electrical Characteristics at 25°C \pm 2°C

• Design reference data

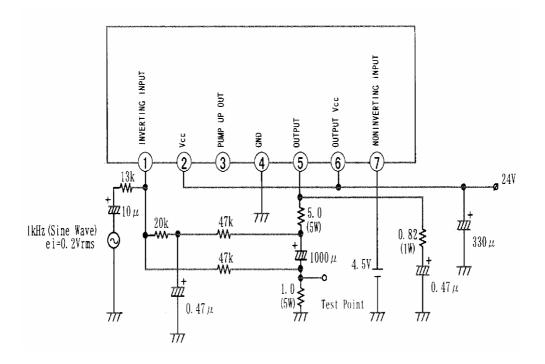
b	Parameter	Symbol	Test		F	Reference	9	Unit	Note
No.	Parameter	Symbol	circuits	Conditions	Min	Тур	Max	Unit	Note
1	Idling current	I ₆	2	$V_{CC} = 24 V$	5	—	50	mA	
2	Thermal protection operating temperature	T _t	1	$V_{CC} = 24 V$ Temperature at output shutdown	150	_		°C	

Note) The above characteristics are theoretical values for designing and not guarantee by 100% inspection.

Description of Test Circuits Test Methods

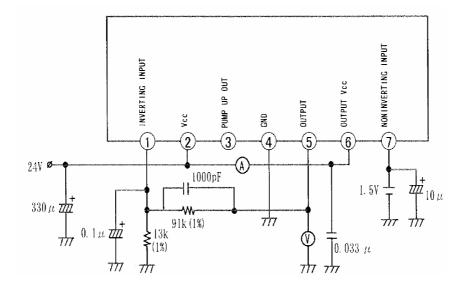
Test Circuit – 1

(Thermal Production Operating Temperature)



Test Circuit – 2

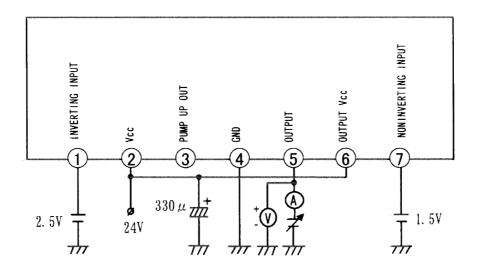
(Mid-point Voltage, Idling Current)



Description of Test Circuits Test Methods (continued)

Test Circuit – 3

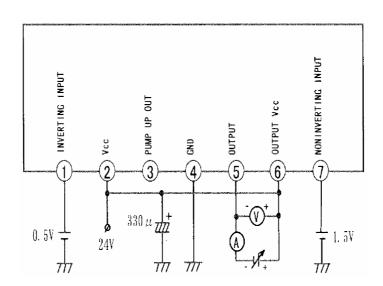
(Output Saturation Voltage (Lower))



Monitor the voltage when the current is 0.8 A.

Test Circuit – 4

(Output Saturation Voltage (Upper))

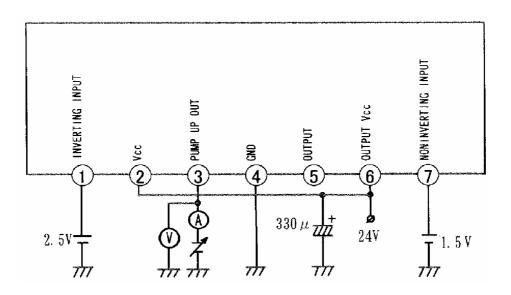


Monitor the voltage when the current is 0.8 A.

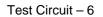
Note) : In case an external power supply is used. set the GND terminal open (floating).

Description of Test Circuits Test Methods (continued)

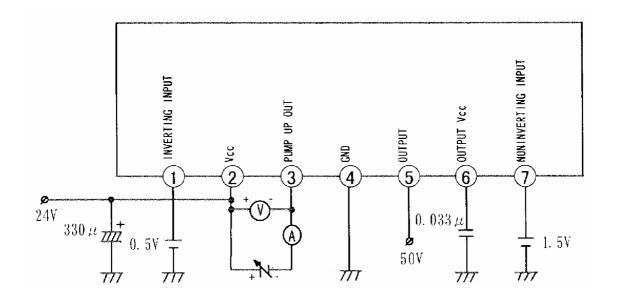
Test Circuit – 5 (Pump-up Charge Saturation Voltage)



Monitor the voltage when the current is 20 mA.



(Pump-up Discharge Saturation Voltage)



Monitor the voltage when the current is 0.8 A.

Note) : In case an external power supply is used. set the GND terminal open (floating).

Technical Data

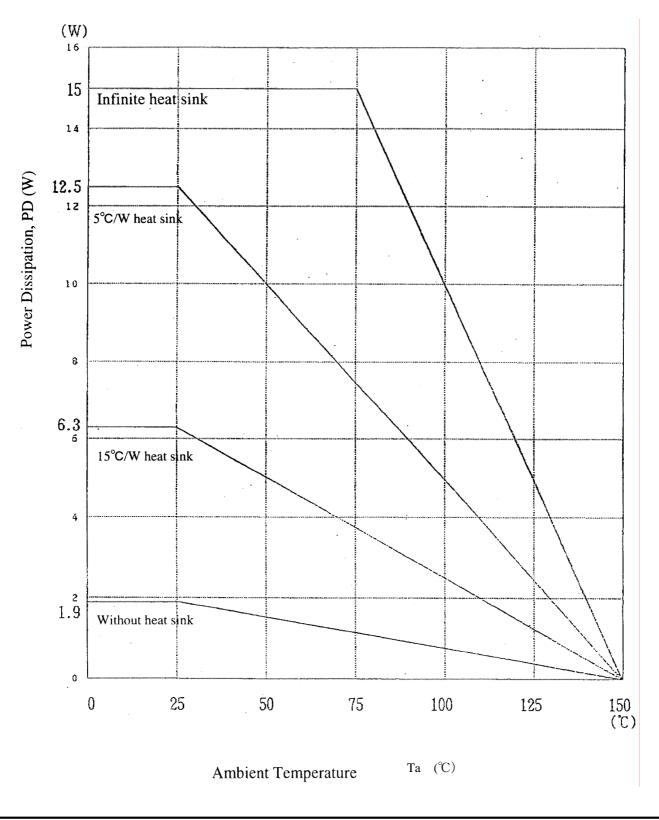
Pin No.	Pin name	Pin voltage (V)	Function	Equivalent circuit
4	GND	DC		_
5	Vertical output	^b ^b 2Vcc	A vertical deflection coil is connected and 1 A to 2 A of deflection current is provided through the pin. At this time, output voltage must be more than Pin 4 voltage.	
6	Vertical output power supply	₹2Vcc	About $V_{CC} \times 2$ for flyback period and $V_{CC} - V_D$ for the other period are supplied.	
7	Non inverting input	DC External bias	About 2 V is supplied. Very high sensitivity may cause abnormal oscillation.	
1	Inverting input	V G -V7	Input signal and CR network for feedback are connected. Very high sensitivity.	
2	Power supply	DC	10 V to 29 V is supplied.	—
3	Pump-up output	₽°0¥ ₽°7¥ ₽°7¥	A capacitor connected between this pin and pin 6 is charged and discharge during fryback pulse in order to supply about $V_{CC} \times 2$ to pin 6.	

- Technical Data (continued)
- Package Power Dissipation

$$P_{D}-T_{a}$$

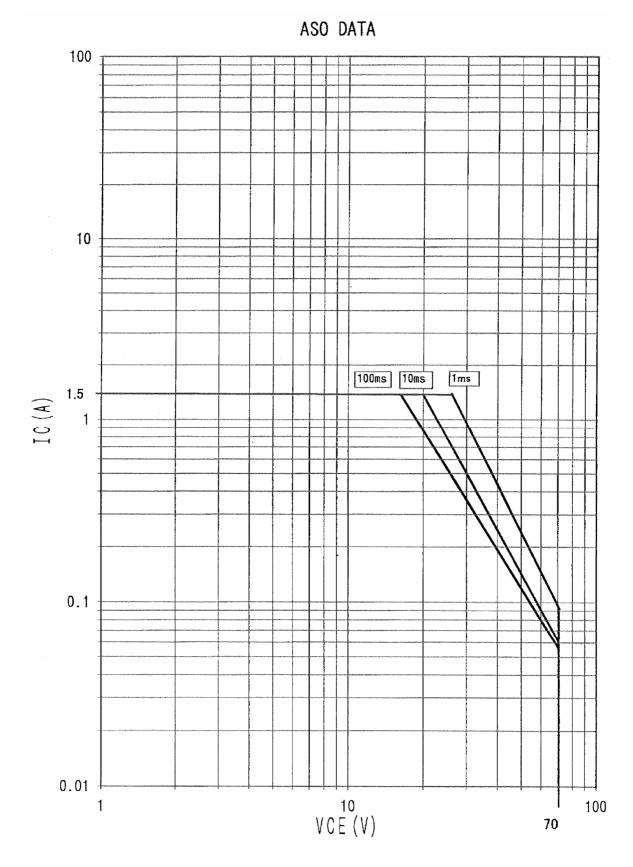
$$R_{th(j-c)} = 5^{\circ}C/W$$

$$R_{th(j-a)} = 65^{\circ}C/W$$



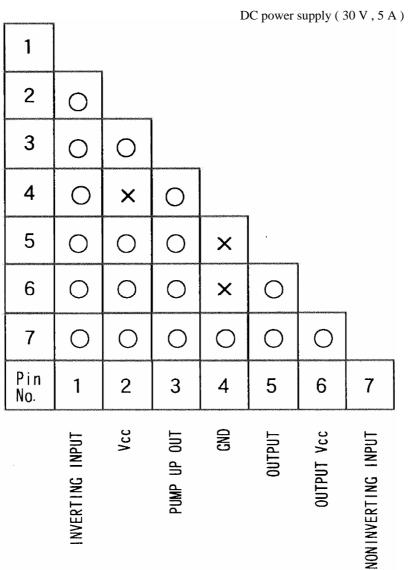
■ Technical Data (continued)

•Safe Operation Area



Precautions for Application

Test result of short between pins



Test condition : $V_{CC} = 30 V$

O: No destruction of IC for pins short for 3secs.

 \times : Destruction of IC for pins short for 1 second.

After destruction, continuous supply of V_{CC} may cause IC package to crack.

To prevent this problem, insert resistance ($2~\Omega~$ to $3~\Omega$) for over current limited in V_{CC} line.

Precautions for Application (continued)

Maximum Current at Pin 3

This is a regulation of output peak current during the flyback period.

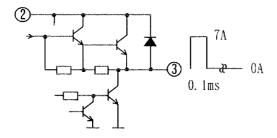
Operating Conditions

 $V_{\rm CC} = 30 \text{ V}$

 $I_{5p-p} = 1.6 A[p-p]$

In case of using external component shown in application circuit (page 4),

 I_3 is tolerated up to 7 A ($I_3 \le 7$ A) with 0.1 m sec single pulse on condition that V_{2-3} is less than 30 V ($V_{2-3} \le 30$ V).



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